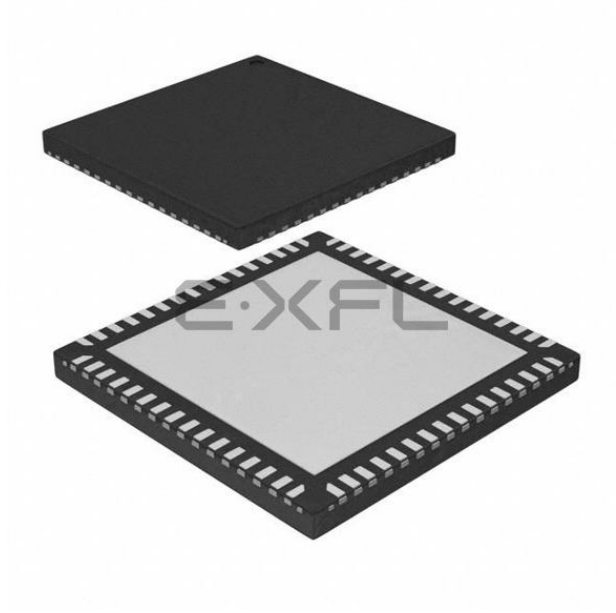

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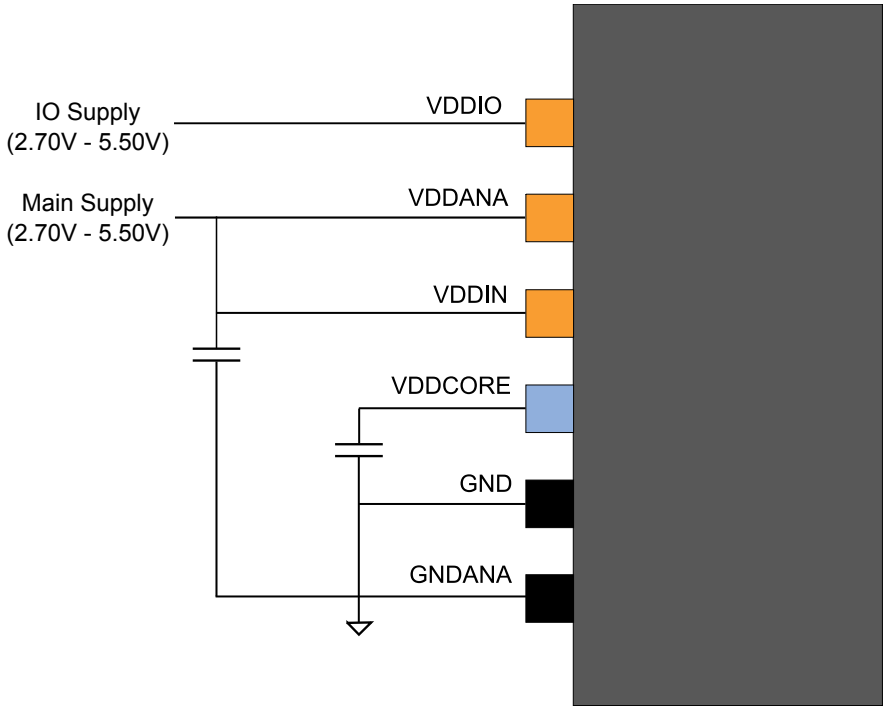
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, WDT
Number of I/O	52
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 12x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad
Supplier Device Package	64-QFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsamc20j16a-mnt

Figure 7-4. Power Supply Connection for Dual Supply Mode



7.2.4 Power-Up Sequence

7.2.4.1 Minimum Rise Rate

The integrated Power-on Reset (POR) circuitry, monitoring the VDDIN power supply, requires a minimum rise rate.

7.2.4.2 Maximum Rise Rate

The rise rate of the power supply must not exceed the values described in Electrical Characteristics.

7.3 Power-Up

This section summarizes the power-up sequence of the SAM C20/C21. The behavior after power-up is controlled by the Power Manager.

7.3.1 Starting of Clocks

After power-up, the device is set to its initial state and kept in reset, until the power has stabilized throughout the device. Once the power has stabilized, the device will use a 4MHz clock. This clock is derived from the 48MHz Internal Oscillator (OSC48M), which is configured to provide a 4MHz clock and used as a clock source for generic clock generator 0. Generic clock generator 0 is the main clock for the Power Manager (PM).

Some synchronous system clocks are active, allowing software execution.

Refer to the “Clock Mask Register” in the Power Manager for the list of default peripheral clocks running. Synchronous system clocks that are running are by default not divided and receive a 4MHz clock through generic clock generator 0. Other generic clocks are disabled.

7.3.2 I/O Pins

After power-up, the I/O pins are tri-stated.

Related Links

GCLK - Generic Clock Controller

20.6.3 Clock Failure Detection Operation

The Clock Failure Detector (CFD) allows the user to monitor the external clock or crystal oscillator signal provided by the external oscillator (XOSC). The CFD detects failing operation of the XOSC clock with reduced latency, and allows to switch to a safe clock source in case of clock failure. The user can also switch from the safe clock back to XOSC in case of recovery. The safe clock is derived from the OSC48M oscillator with a configurable prescaler. This allows to configure the safe clock in order to fulfill the operative conditions of the microcontroller.

In sleep modes, CFD operation is automatically disabled when the external oscillator is not requested to run by a peripheral. See the Sleep Behavior table above when this is the case.

The user interface registers allow to enable, disable, and configure the CFD. The Status register provides status flags on failure and clock switch conditions. The CFD can optionally trigger an interrupt or an event when a failure is detected.

Clock Failure Detection

The CFD is reset only at power-on (POR). The CFD does not monitor the XOSC clock when the oscillator is disabled (XOSCCTRL.ENABLE=0).

Before starting CFD operation, the user must start and enable the safe clock source (OSC48M oscillator).

CFD operation is started by writing a '1' to the CFD Enable bit in the External Oscillator Control register (XOCCTRL.CFDEN). After starting or restarting the XOSC, the CFD does not detect failure until the start-up time has elapsed. The start-up time is configured by the Oscillator Start-Up Time in the External Multipurpose Crystal Oscillator Control register (XOSCCTRL.STARTUP). Once the XOSC Start-Up Time is elapsed, the XOSC clock is constantly monitored.

During a period of 4 safe clocks (monitor period), the CFD watches for a clock activity from the XOSC. There must be at least one rising and one falling XOSC clock edge during 4 safe clock periods to meet non-failure conditions. If no or insufficient activity is detected, the failure status is asserted: The Clock Failure Detector status bit in the Status register (STATUS.CLKFAIL) and the Clock Failure Detector interrupt flag bit in the Interrupt Flag register (INTFLAG.CLKFAIL) are set. If the CLKFAIL bit in the Interrupt Enable Set register (INTENSET.CLKFAIL) is set, an interrupt is generated as well. If the Event Output enable bit in the Event Control register (EVCTRL.CFDEO) is set, an output event is generated, too.

After a clock failure was issued the monitoring of the XOSC clock is continued, and the Clock Failure Detector status bit in the Status register (STATUS.CLKFAIL) reflects the current XOSC activity.

Clock Switch

When a clock failure is detected, the XOSC clock is replaced by the safe clock in order to maintain an active clock during the XOSC clock failure. The safe clock source is the OSC48M oscillator clock. The safe clock source can be scaled down by a configurable prescaler to ensure that the safe clock frequency does not exceed the operating conditions selected by the application. When the XOSC clock is switched to the safe clock, the Clock Switch bit in the Status register (STATUS.CLKSW) is set.

When the CFD has switched to the safe clock, the XOSC is not disabled. If desired, the application must take the necessary actions to disable the oscillator. The application must also take the necessary actions to configure the system clocks to continue normal operations.

Bit 2 – FREQCORR: Frequency Correction Synchronization Busy Status

Value	Description
0	Write synchronization for FREQCORR register is complete.
1	Write synchronization for FREQCORR register is ongoing.

Bit 1 – ENABLE: Enable Synchronization Busy Status

Value	Description
0	Write synchronization for CTRLA.ENABLE bit is complete.
1	Write synchronization for CTRLA.ENABLE bit is ongoing.

Bit 0 – SWRST: Software Reset Synchronization Busy Status

Value	Description
0	Write synchronization for CTRLA.SWRST bit is complete.
1	Write synchronization for CTRLA.SWRST bit is ongoing.

24.8.8 Frequency Correction

Name: FREQCORR
Offset: 0x14
Reset: 0x00
Property: PAC Write-Protection, Write-Synchronized

Bit	7	6	5	4	3	2	1	0
	SIGN	VALUE[6:0]						
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit 7 – SIGN: Correction Sign

Value	Description
0	The correction value is positive, i.e., frequency will be decreased.
1	The correction value is negative, i.e., frequency will be increased.

Bits 6:0 – VALUE[6:0]: Correction Value
These bits define the amount of correction applied to the RTC prescaler.

Value	Description
0	Correction is disabled and the RTC frequency is unchanged.
1 - 127	The RTC frequency is adjusted according to the value.

24.8.9 Counter Value in COUNT32 mode (CTRLA.MODE=0)

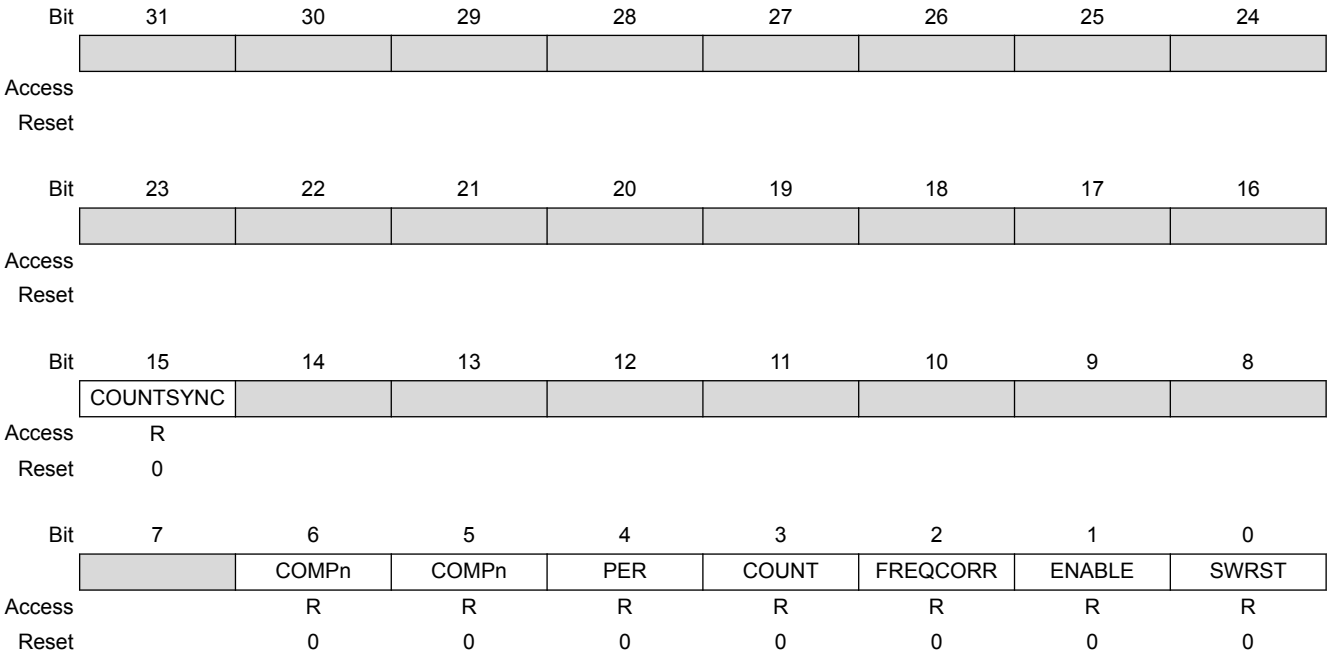
Name: COUNT
Offset: 0x18
Reset: 0x00000000
Property: PAC Write-Protection, Write-Synchronized, Read-Synchronized

This bit controls the functionality when the CPU is halted by an external debugger.

Value	Description
0	The RTC is halted when the CPU is halted by an external debugger.
1	The RTC continues normal operation when the CPU is halted by an external debugger.

24.10.7 Synchronization Busy in COUNT16 mode (CTRLA.MODE=1)

Name: SYNCBUSY
Offset: 0x10
Reset: 0x00000000
Property: -



Bit 15 – COUNTSYNC: Count Read Sync Enable Synchronization Busy Status

Value	Description
0	Write synchronization for CTRLA.COUNTSYNC bit is complete.
1	Write synchronization for CTRLA.COUNTSYNC bit is ongoing.

Bits 6:5 – COMPn: Compare n Synchronization Busy Status [n = 1..0]

Value	Description
0	Write synchronization for COMPn register is complete.
1	Write synchronization for COMPn register is ongoing.

Bit 4 – PER: Period Synchronization Busy Status

Value	Description
0	Write synchronization for PER register is complete.
1	Write synchronization for PER register is ongoing.

Writing a '1' to this bit when both the DMAC and the CRC module are disabled (DMAENABLE and CRCENABLE are '0') resets all registers in the DMAC (except DBGCTRL) to their initial state. If either the DMAC or CRC module is enabled, the Reset request will be ignored and the DMAC will return an access error.

Value	Description
0	There is no Reset operation ongoing.
1	A Reset operation is ongoing.

25.8.2 CRC Control

Name: CRCCTRL
Offset: 0x02 [ID-00001ece]
Reset: 0x0000
Property: PAC Write-Protection, Enable-Protected

Bit	15	14	13	12	11	10	9	8
			CRCSRC[5:0]					
Access			R/W	R/W	R/W	R/W	R/W	R/W
Reset			0	0	0	0	0	0

Bit	7	6	5	4	3	2	1	0
					CRCPOLY[1:0]		CRCBEATSIZE[1:0]	
Access					R/W	R/W	R/W	R/W
Reset					0	0	0	0

Bits 13:8 – CRCSRC[5:0]: CRC Input Source
These bits select the input source for generating the CRC, as shown in the table below. The selected source is locked until either the CRC generation is completed or the CRC module is disabled. This means the CRCSRC cannot be modified when the CRC operation is ongoing. The lock is signaled by the CRCBUSY status bit. CRC generation complete is generated and signaled from the selected source when used with the DMA channel.

Value	Name	Description
0x00	NOACT	No action
0x01	IO	I/O interface
0x02-0x1F	-	Reserved
0x20	CHN	DMA channel 0
0x21	CHN	DMA channel 1
0x22	CHN	DMA channel 2
0x23	CHN	DMA channel 3
0x24	CHN	DMA channel 4
0x25	CHN	DMA channel 5
0x26	CHN	DMA channel 6
0x27	CHN	DMA channel 7
0x28	CHN	DMA channel 8
0x29	CHN	DMA channel 9
0x2A	CHN	DMA channel 10

Bit	31	30	29	28	27	26	25	24
Access								
Reset								

Bit	23	22	21	20	19	18	17	16
Access								
Reset								

Bit	15	14	13	12	11	10	9	8
					PENDCH11	PENDCH10	PENDCH9	PENDCH8
Access					R	R	R	R
Reset					0	0	0	0

Bit	7	6	5	4	3	2	1	0
	PENDCH7	PENDCH6	PENDCH5	PENDCH4	PENDCH3	PENDCH2	PENDCH1	PENDCH0
Access	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bits 0, 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11 – PENDCH: Pending Channel n [n=11..0]
This bit is cleared when trigger execution defined by channel trigger action settings for DMA channel n is started, when a bus error for DMA channel n is detected or when DMA channel n is disabled. For details on trigger action settings, refer to CHCTRLB.TRIGACT.

This bit is set when a transfer is pending on DMA channel n.

Related Links
CHCTRLB

25.8.14 Active Channel and Levels

Name: ACTIVE
Offset: 0x30
Reset: 0x00000000
Property: -

Related Links

External Pin Processing

26.6.2 Basic Operation

26.6.2.1 Initialization

The EIC must be initialized in the following order:

1. Enable CLK_EIC_APB
2. If required, configure the NMI by writing the Non-Maskable Interrupt Control register (NMICTRL)
3. Enable GCLK_EIC or CLK_ULP32K when one of the following configuration is selected:
   - the NMI uses edge detection or filtering.
   - one EXTINT uses filtering.
   - one EXTINT uses synchronous edge detection.
   - one EXTINT uses debouncing.

   GCLK_EIC is used when a frequency higher than 32KHz is required for filtering.

   CLK_ULP32K is recommended when power consumption is the priority. For CLK_ULP32K write a '1' to the Clock Selection bit in the Control A register (CTRLA.CKSEL).
4. Configure the EIC input sense and filtering by writing the Configuration n register (CONFIG0, CONFIG1, CONFIG2, CONFIG3).
5. Optionally, enable the asynchronous mode.
6. Optionally, enable the debouncer mode.
7. Enable the EIC by writing a ‘1’ to CTRLA.ENABLE.

The following bits are enable-protected, meaning that it can only be written when the EIC is disabled (CTRLA.ENABLE=0):

- Clock Selection bit in Control A register (CTRLA.CKSEL)

The following registers are enable-protected:

- Event Control register (EVCTRL)
- Configuration n register (CONFIG...)
- External Interrupt Asynchronous Mode register (ASYNCH)
- Debouncer Enable register (DEBOUNCEN)
- Debounce Prescaler register (DPRESCALER)

Enable-protected bits in the CTRLA register can be written at the same time when setting CTRLA.ENABLE to '1', but not at the same time as CTRLA.ENABLE is being cleared.

Enable-protection is denoted by the "Enable-Protected" property in the register description.

26.6.2.2 Enabling, Disabling, and Resetting

The EIC is enabled by writing a '1' the Enable bit in the Control A register (CTRLA.ENABLE). The EIC is disabled by writing CTRLA.ENABLE to '0'.

The EIC is reset by setting the Software Reset bit in the Control register (CTRLA.SWRST). All registers in the EIC will be reset to their initial state, and the EIC will be disabled.

Refer to the CTRLA register description for details.

- 32-bit 0x2 written to address 1
  - Page buffer[127:0] = 0xFFFFFFFF_00000001_00000002_FFFFFFFF
  - PBLDATA[63:0] = 0x00000002_FFFFFFFF
- 32-bit 0x3 written to address 3
  - Page buffer[127:0] = 0x00000003_FFFFFFFF_00000002_FFFFFFFF
  - PBLDATA[63:0] = 0x00000003_0xFFFFFFFF

Both the NVM main array and the RWWEE array share the same page buffer. Writing to the NVM block via the AHB bus is performed by a load operation to the page buffer. For each AHB bus write, the address is stored in the ADDR register. After the page buffer has been loaded with the required number of bytes, the page can be written to the NVM main array or the RWWEE array by setting CTRLA.CMD to 'Write Page' or 'RWWEE Write Page', respectively, and setting the key value to CMDEX. The LOAD bit in the STATUS register indicates whether the page buffer has been loaded or not. Before writing the page to memory, the accessed row must be erased.

Automatic page writes are enabled by writing the manual write bit to zero (CTRLB.MANW=0). This will trigger a write operation to the page addressed by ADDR when the last location of the page is written.

Because the address is automatically stored in ADDR during the I/O bus write operation, the last given address will be present in the ADDR register. There is no need to load the ADDR register manually, unless a different page in memory is to be written.

Procedure for Manual Page Writes (CTRLB.MANW=1)
The row to be written to must be erased before the write command is given.

- Write to the page buffer by addressing the NVM main address space directly
- Write the page buffer to memory: CTRL.CMD='Write Page' and CMDEX
- The READY bit in the INTFLAG register will be low while programming is in progress, and access through the AHB will be stalled

Procedure for Automatic Page Writes (CTRLB.MANW=0)
The row to be written to must be erased before the last write to the page buffer is performed.

Note that partially written pages must be written with a manual write.

- Write to the page buffer by addressing the NVM main address space directly.
  When the last location in the page buffer is written, the page is automatically written to NVM main address space.
- INTFLAG.READY will be zero while programming is in progress and access through the AHB will be stalled.

27.6.4.4 Page Buffer Clear

The page buffer is automatically set to all '1' after a page write is performed. If a partial page has been written and it is desired to clear the contents of the page buffer, the Page Buffer Clear command can be used.

27.6.4.5 Erase Row

Before a page can be written, the row containing that page must be erased. The Erase Row command can be used to erase the desired row in the NVM main address space. The RWWEE Erase Row can be used to erase the desired row in the RWWEE array. Erasing the row sets all bits to '1'. If the row resides in a region that is locked, the erase will not be performed and the Lock Error bit in the Status register (STATUS.LOCKE) will be set.

Procedure for Erase Row

- Write the address of the row to erase to ADDR. Any address within the row can be used.

When the asynchronous path is selected, the channel cannot generate any interrupts, and the Channel Status register (CHSTATUS) is always zero. The edge detection is not required and must be disabled by software. Each peripheral event user has to select which event edge must trigger internal actions. For further details, refer to each peripheral chapter description.

Synchronous Path

The synchronous path should be used when the event generator and the event channel share the same generator for the generic clock. If they do not share the same clock, a logic change from the event generator to the event channel might not be detected in the channel, which means that the event will not be propagated to the event user. For details on generic clock generators, refer to *GCLK - Generic Clock Controller*.

When using the synchronous path, the channel is able to generate interrupts. The channel busy n bit in the Channel Status register (CHSTATUS.CHBUSYn) are also updated and available for use.

Resynchronized Path

The resynchronized path are used when the event generator and the event channel do not share the same generator for the generic clock. When the resynchronized path is used, resynchronization of the event from the event generator is done in the channel. For details on generic clock generators, refer to *GCLK - Generic Clock Controller*.

When the resynchronized path is used, the channel is able to generate interrupts. The channel busy n bits in the Channel Status register (CHSTATUS.CHBUSYn) are also updated and available for use.

Related Links

GCLK - Generic Clock Controller

29.6.2.7 Edge Detection

When synchronous or resynchronized paths are used, edge detection must be enabled. The event system can execute edge detection in three different ways:

- Generate an event only on the rising edge
- Generate an event only on the falling edge
- Generate an event on rising and falling edges.

Edge detection is selected by writing to the Edge Selection bit group of the Channel register (CHANNELn.EDGSEL).

29.6.2.8 Event Latency

An event from an event generator is propagated to an event user with different latency, depending on event channel configuration.

- Asynchronous Path: The maximum routing latency of an external event is related to the internal signal routing and it is device dependent.
- Resynchronized Path: The maximum routing latency of an external event is three GCLK_EVSYS_CHANNEL_n clock cycles.

The maximum propagation latency of a user event to the peripheral clock core domain is three peripheral clock cycles.

The event generators, event channel and event user clocks ratio must be selected in relation with the internal event latency constraints. Events propagation or event actions in peripherals may be lost if the clock setup violates the internal latencies.

Table 30-3. BAUD Register Value vs. Baud Frequency

BAUD Register Value	Serial Engine CPF	f_{BAUD} at 48MHz Serial Engine Frequency (f_{REF})
0 – 406	160	3MHz
407 – 808	161	2.981MHz
809 – 1205	162	2.963MHz
...	...	...
65206	31775	15.11kHz
65207	31871	15.06kHz
65208	31969	15.01kHz

30.6.3 Additional Features

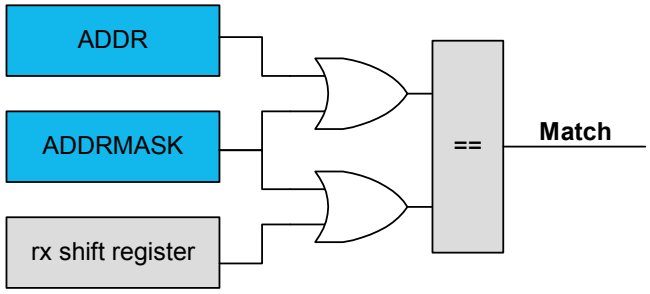
30.6.3.1 Address Match and Mask

The SERCOM address match and mask feature is capable of matching either one address, two unique addresses, or a range of addresses with a mask, based on the mode selected. The match uses seven or eight bits, depending on the mode.

Address With Mask

An address written to the Address bits in the Address register (ADDR.ADDR), and a mask written to the Address Mask bits in the Address register (ADDR.ADDRMASK) will yield an address match. All bits that are masked are not included in the match. Note that writing the ADDR.ADDRMASK to 'all zeros' will match a single unique address, while writing ADDR.ADDRMASK to 'all ones' will result in all addresses being accepted.

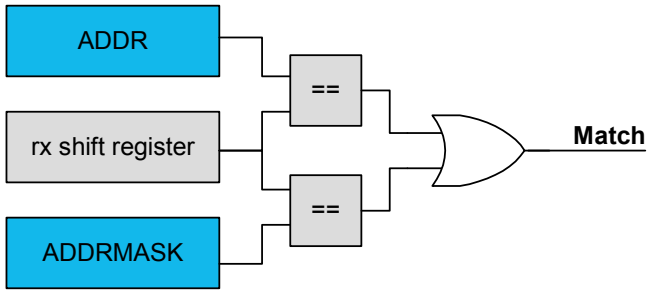
Figure 30-4. Address With Mask



Two Unique Addresses

The two addresses written to ADDR and ADDRMASK will cause a match.

Figure 30-5. Two Unique Addresses



Bit	15	14	13	12	11	10	9	8
						LENERR	SEXTTOUT	MEXTTOUT
Access						R/W	R/W	R/W
Reset						0	0	0

Bit	7	6	5	4	3	2	1	0
	CLKHOLD	LOWTOUT	BUSSTATE[1:0]			RXNACK	ARBLOST	BUSERR
Access	R	R/W	R	R		R	R/W	R/W
Reset	0	0	0	0		0	0	0

Bit 10 – LENERR: Transaction Length Error
This bit is set when automatic length is used for a DMA transaction and the slave sends a NACK before ADDR.LEN bytes have been written by the master.

Writing '1' to this bit location will clear STATUS.LENERR. This flag is automatically cleared when writing to the ADDR register.

Writing '0' to this bit has no effect.

This bit is not write-synchronized.

Bit 9 – SEXTTOUT: Slave SCL Low Extend Time-Out
This bit is set if a slave SCL low extend time-out occurs.

This bit is automatically cleared when writing to the ADDR register.

Writing '1' to this bit location will clear SEXTTOUT. Normal use of the I^2C interface does not require the SEXTTOUT flag to be cleared by this method.

Writing '0' to this bit has no effect.

This bit is not write-synchronized.

Bit 8 – MEXTTOUT: Master SCL Low Extend Time-Out
This bit is set if a master SCL low time-out occurs.

Writing '1' to this bit location will clear STATUS.MEXTTOUT. This flag is automatically cleared when writing to the ADDR register.

Writing '0' to this bit has no effect.

This bit is not write-synchronized.

Bit 7 – CLKHOLD: Clock Hold
This bit is set when the master is holding the SCL line low, stretching the I^2C clock. Software should consider this bit when INTFLAG.SB or INTFLAG.MB is set.

This bit is cleared when the corresponding interrupt flag is cleared and the next operation is given.

Writing '0' to this bit has no effect.

Writing '1' to this bit has no effect.

This bit is not write-synchronized.

Bit 6 – LOWTOUT: SCL Low Time-Out
This bit is set if an SCL low time-out occurs.

Bit	31	30	29	28	27	26	25	24
	TOn	TOn	TOn	TOn	TOn	TOn	TOn	TOn
Access	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	23	22	21	20	19	18	17	16
	TOn	TOn	TOn	TOn	TOn	TOn	TOn	TOn
Access	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	15	14	13	12	11	10	9	8
	TOn	TOn	TOn	TOn	TOn	TOn	TOn	TOn
Access	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bit	7	6	5	4	3	2	1	0
	TOn	TOn	TOn	TOn	TOn	TOn	TOn	TOn
Access	R	R	R	R	R	R	R	R
Reset	0	0	0	0	0	0	0	0

Bits 31:0 – TOn: Transmission Occurred

Each Tx Buffer has its own Transmission Occurred bit.

The bits are set when the corresponding TXBRP bit is cleared after a successful transmission.

The bits are reset when a new transmission is requested by writing ‘1’ to the corresponding bit of register TXBAR.

34.8.42 Tx Buffer Cancellation Finished

Name: TXBCF
Offset: 0xDC [ID-0000a4bb]
Reset: 0x00000000
Property: Read-only

35.5.5 Interrupts

The interrupt request line is connected to the Interrupt Controller. In order to use interrupt requests of this peripheral, the Interrupt Controller (NVIC) must be configured first. Refer to *Nested Vector Interrupt Controller* for details.

Related Links

Nested Vector Interrupt Controller

35.5.6 Events

The events of this peripheral are connected to the Event System.

Related Links

EVSYS – Event System

35.5.7 Debug Operation

When the CPU is halted in debug mode, this peripheral will halt normal operation. This peripheral can be forced to continue operation during debugging - refer to the Debug Control (DBGCTRL) register for details.

Related Links

DBGCTRL

35.5.8 Register Access Protection

Registers with write-access can be optionally write-protected by the Peripheral Access Controller (PAC), except for the following:

- Interrupt Flag Status and Clear register (INTFLAG)
- Status register (STATUS)
- Count register (COUNT)
- Period and Period Buffer registers (PER, PERBUF)
- Compare/Capture Value registers and Compare/Capture Value Buffer registers (CCx, CCBUFx)

Note: Optional write-protection is indicated by the "PAC Write-Protection" property in the register description.

When the CPU is halted in debug mode, all write-protection is automatically disabled. Write-protection does not apply for accesses through an external debugger.

35.5.9 Analog Connections

Not applicable.

35.6 Functional Description

35.6.1 Principle of Operation

The following definitions are used throughout the documentation:

Table 35-2. Timer/Counter Definitions

Name	Description
TOP	The counter reaches TOP when it becomes equal to the highest value in the count sequence. The TOP value can be the same as Period (PER)

Offset	Name	Bit Pos.								
0x2F		31:24	PERBUF[31:24]							
0x30	CCBUF0	7:0	CCBUF[7:0]							
0x31		15:8	CCBUF[15:8]							
0x32		23:16	CCBUF[23:16]							
0x33		31:24	CCBUF[31:24]							
0x34	CCBUF1	7:0	CCBUF[7:0]							
0x35		15:8	CCBUF[15:8]							
0x36		23:16	CCBUF[23:16]							
0x37		31:24	CCBUF[31:24]							

35.7.3.1 Control A

Name: CTRLA
Offset: 0x00
Reset: 0x00000000
Property: PAC Write-Protection, Write-Synchronized, Enable-Protected

Bit	31	30	29	28	27	26	25	24
				CAPTMODE1[1:0]			CAPTMODE0[1:0]	
Access				R/W	R/W		R/W	R/W
Reset				0	0		0	0

Bit	23	22	21	20	19	18	17	16
			COPEN1	COPEN0			CAPTEN1	CAPTEN0
Access			R/W	R/W			R/W	R/W
Reset			0	0			0	0

Bit	15	14	13	12	11	10	9	8
					ALOCK	PRESCALER[2:0]		
Access					R/W	R/W	R/W	R/W
Reset					0	0	0	0

Bit	7	6	5	4	3	2	1	0
	ONDEMAND	RUNSTDBY	PRESCSYNC[1:0]		MODE[1:0]		ENABLE	SWRST
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	W
Reset	0	0	0	0	0	0	0	0

Bits 28:27 – CAPTMODE1[1:0]: Capture mode Channel 1
These bits select the channel 1 capture mode.

Value	Name	Description
0x0	DEFAULT	Default capture
0x1	CAPTMIN	Minimum capture
0x2	CAPTMAX	Maximum capture
0x3		Reserved

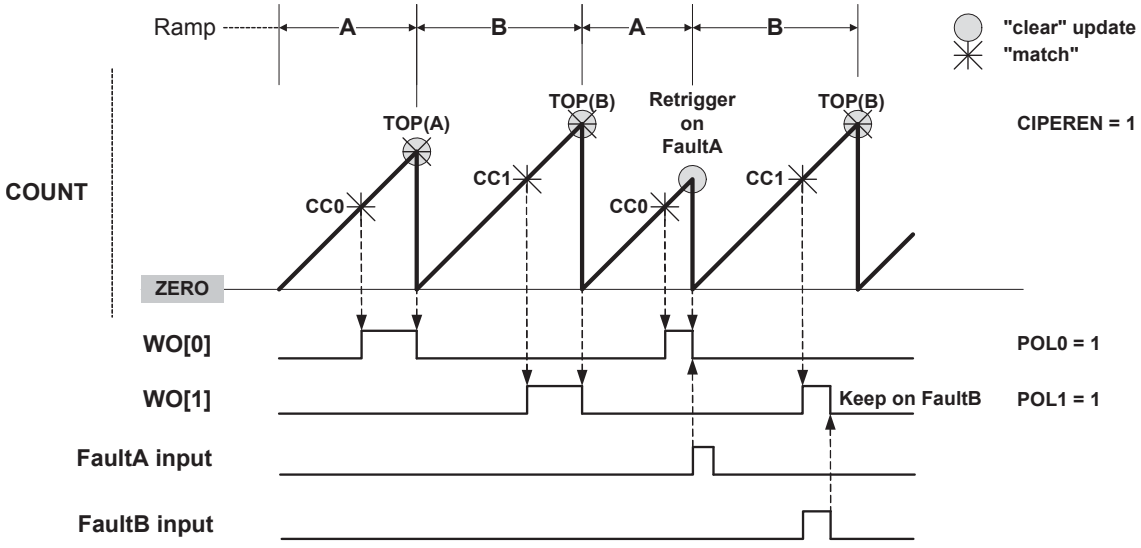
Bits 25:24 – CAPTMODE0[1:0]: Capture mode Channel 0
These bits select the channel 0 capture mode.

A, odd channel output is disabled, and in cycle B, even channel output is disabled. The ramp index changes after each update, but can be software modified using the Ramp index command bits in Control B Set register (CTRLBSET.IDXCMD).

Standard RAMP2 (RAMP2) Operation

Ramp A and B periods are controlled by the PER register value. The PER value can be different on each ramp by the Circular Period buffer option in the Wave register (WAVE.CIPEREN=1). This mode uses a two-channel TCC to generate two output signals, or one output signal with another CC channel enabled in capture mode.

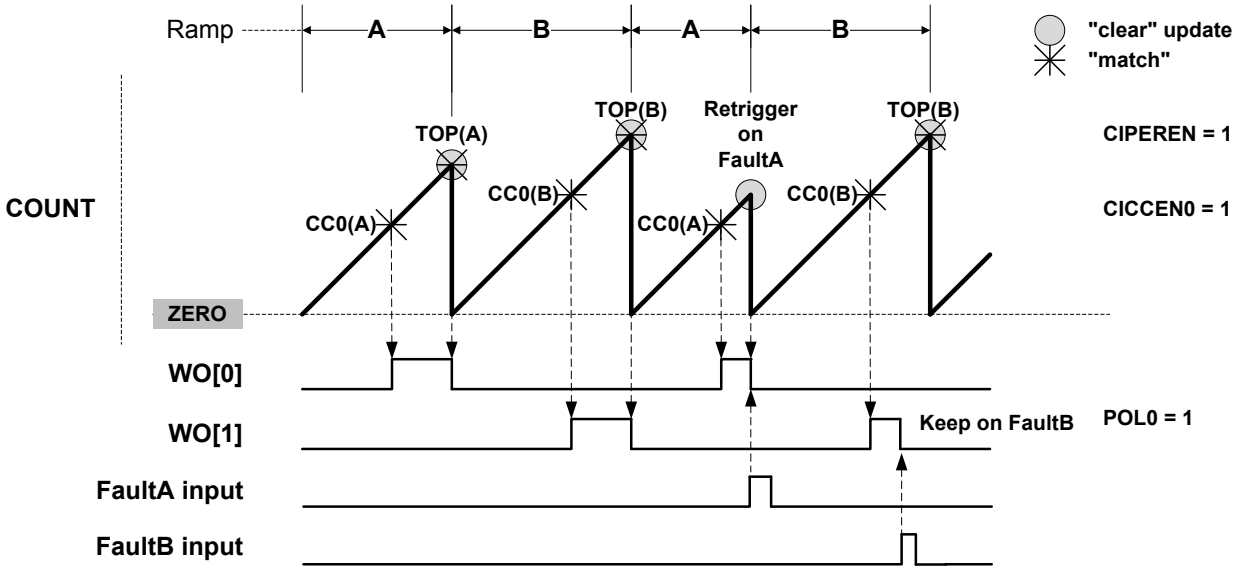
Figure 36-18. RAMP2 Standard Operation



Alternate RAMP2 (RAMP2A) Operation

Alternate RAMP2 operation is similar to RAMP2, but CC0 controls both WO[0] and WO[1] waveforms when the corresponding circular buffer option is enabled (CIPEREN=1). The waveform polarity is the same on both outputs. Channel 1 can be used in capture mode.

Figure 36-19. RAMP2 Alternate Operation



Name: CTRL
Offset: 0x00 [ID-00000485]
Reset: 0x00
Property: PAC Write-Protection

Bit	7	6	5	4	3	2	1	0
		RUNSTDBY					ENABLE	SWRST
Access		R/W					R/W	W
Reset		0					0	0

Bit 6 – RUNSTDBY: Run in Standby
This bit indicates if the GCLK_CCL clock must be kept running in standby mode. The setting is ignored for configurations where the generic clock is not required. For details refer to Sleep Mode Operation.

Value	Description
0	Generic clock is not required in standby sleep mode.
1	Generic clock is required in standby sleep mode.

Bit 1 – ENABLE: Enable

Value	Description
0	The peripheral is disabled.
1	The peripheral is enabled.

Bit 0 – SWRST: Software Reset
Writing a '0' to this bit has no effect.

Writing a '1' to this bit resets all registers in the CCL to their initial state.

Value	Description
0	There is no reset operation ongoing.
1	The reset operation is ongoing.

37.8.2 Sequential Control x

Name: SEQCTRL
Offset: 0x04 + n*0x01 [n=0..1]
Reset: 0x00
Property: PAC Write-Protection, Enable-Protected

Bit	7	6	5	4	3	2	1	0
					SEQSEL[3:0]			
Access					R/W	R/W	R/W	R/W
Reset					0	0	0	0

Bits 3:0 – SEQSEL[3:0]: Sequential Selection
These bits select the sequential configuration:

Sequential Selection

Name: SEQCTRL
Offset: 0x28 [ID-0000120e]
Reset: 0x00000000
Property: PAC Write-Protection

Bit	31	30	29	28	27	26	25	24
	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	23	22	21	20	19	18	17	16
	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	15	14	13	12	11	10	9	8
	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	7	6	5	4	3	2	1	0
	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn	SEQENn
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bits 31:0 – SEQENn: Enable Positive Input in the Sequence
For details on available positive mux selection, refer to INPUTCTRL.MUXENG.

The sequence start from the lowest input, and go to the next enabled input automatically when the conversion is done. If no bits are set the sequence is disabled.

Value	Description
0	Disable the positive input mux n selection from the sequence.
1	Enable the positive input mux n selection to the sequence.

38.8.22 Calibration

Name: CALIB
Offset: 0x2C [ID-0000120e]
Reset: 0x0000
Property: PAC Write-Protection, Enable-Protected

Symbol	Parameters	Conditions	Min	Typ	Max	Unit
		VDD level, BOD setting = 44	4.37	4.51	4.66	
	Step size		-	60	-	mV
VHys(1)	Hysteresis (VBOD+ - VBOD-) BODVDD.LEVEL = 8 to 48	VDD	40	-	75	mV
T_{START}(3)	Startup time	Time from enable to RDY	-	3.1	-	µs

1. These are based on characterization.
2. BODVDD in continuous mode.
3. These are based on simulation. These values are not covered by test or characterization

Table 45-15. Power Consumption(1)

Symbol	Parameters	Conditions	Ta	Typ.	Max	Units
I_{DD}	IDLE, Mode CONT	VDD = 2.7V	Max 85°C	22.5	26.3	µA
		VDD = 5.0V	Typ 25°C	41.0	47.1	
	IDLE, Mode SAMPL	VDD = 2.7V		0.1	1.2	
		VDD = 5.0V		0.1	1.2	
	STANDBY, Mode SAMPL	VDD = 2.7V		0.8	1.6	
		VDD = 5.0V		3.5	4.6	

1. These are based on characterization.

Related Links

NVM User Row Mapping

45.10.3 Voltage Regulator Characteristics

Table 45-16. Voltage Regulator Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units
VDDIN	Input voltage range	2.7	-	5.5	V
VDDCORE	DC calibrated output voltage	-	1.23	-	V

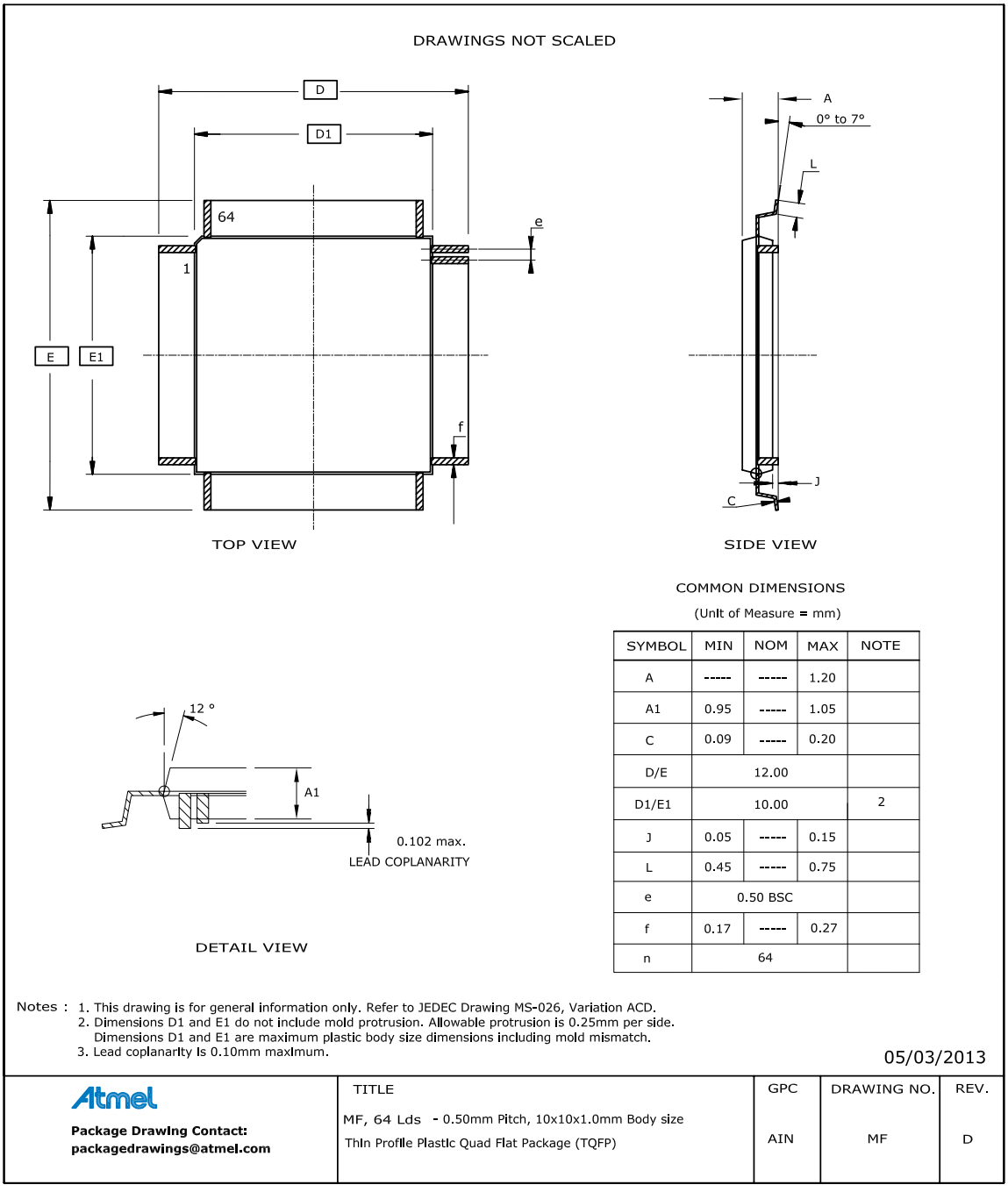
Table 45-17. Decoupling Requirements

Symbol	Parameter	Conditions	Typ.	Units
C_{in}	Input regulator capacitor, between VDDIN and GND		1	µF
		Ceramic dielectric X7R	100	nF
C_{out}	Output regulator capacitor, between VDDCORE and GND	ESR Max. = 0.5Ω	1	µF
		Ceramic dielectric X7R	100	nF

Table 48-4. Package Reference

JEDEC Drawing Reference	MS-026
JESD97 Classification	e3

48.2.2 64 pin TQFP



COMMON DIMENSIONS

(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	-----	-----	1.20	
A1	0.95	-----	1.05	
C	0.09	-----	0.20	
D/E		12.00		
D1/E1		10.00		2
J	0.05	-----	0.15	
L	0.45	-----	0.75	
e		0.50 BSC		
f	0.17	-----	0.27	
n		64		

Notes : 1. This drawing is for general information only. Refer to JEDEC Drawing MS-026, Variation ACD.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
3. Lead coplanarity is 0.10mm maximum.

05/03/2013

Atmel	TITLE	GPC	DRAWING NO.	REV.
Package Drawing Contact: **packagedrawings@atmel.com**	MF, 64 Lds - 0.50mm Pitch, 10x10x1.0mm Body size Thin Profile Plastic Quad Flat Package (TQFP)	AIN	MF	D

Table 48-5. Device and Package Maximum Weight

300	mg

2. Decoupling capacitors should be placed close to the device for each supply pin pair in the signal group, low ESR capacitors should be used for better decoupling.

3. An inductor should be added between the external power and the V_{DD} for power filtering.

4. A ferrite bead has better filtering performance compared to standard inductor at high frequencies. A ferrite bead can be added between the main power supply (V_{DD}) and V_{DDANA} to prevent digital noise from entering the analog power domain. The bead should provide enough impedance (e.g. 50Ω at 20MHz and 220Ω at 100MHz) to separate the digital and analog power domains. Make sure to select a ferrite bead designed for filtering applications with a low DC resistance to avoid a large voltage drop across the ferrite bead.

49.4 External Analog Reference Connections

The following schematic checklist is only necessary if the application is using one or more of the external analog references. If the internal references are used instead, the following circuits are not necessary.

Figure 49-3. External Analog Reference Schematic With Two References